TEL +86-513-68528666

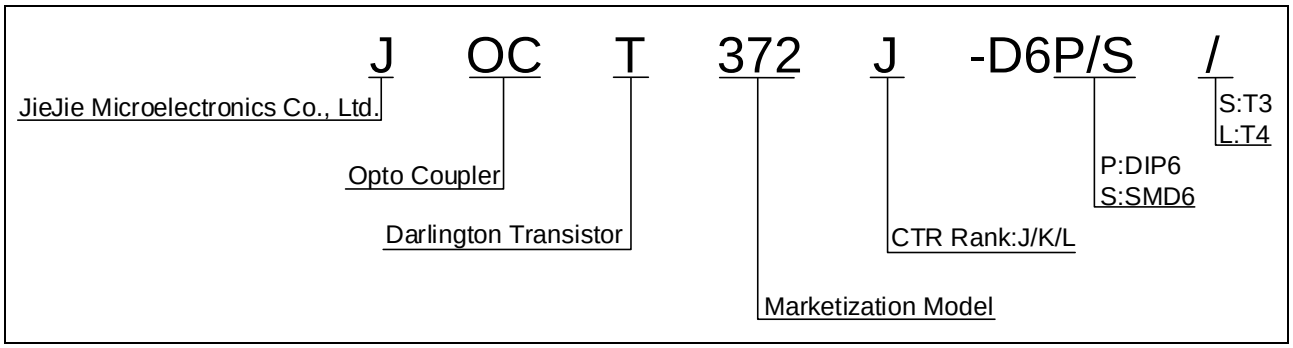
Storage Temperature	T_{stg}	-55~+125	
Soldering Temperature	T_{sol}	260	

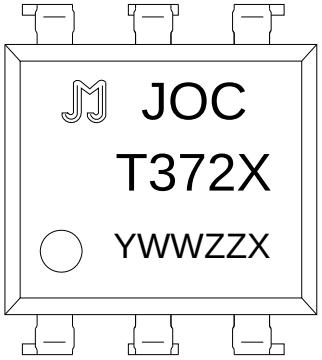
: μ

:

(Temperature=25°C)

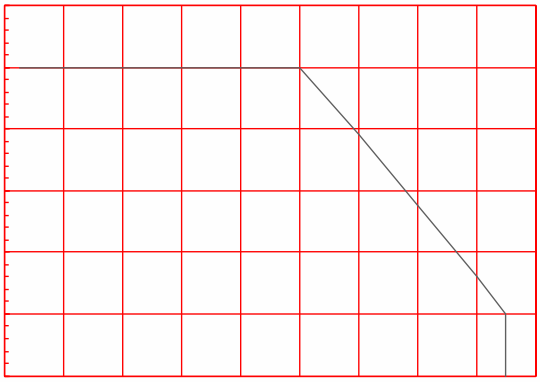
	Forward Voltage	V_F	I_F=10mA	-	1.2	1.5	V
Input	Reverse Current	I_R					


J
OC
T
372
J
-D6P/S
/
JieJie Microelectronics Co., Ltd.
Opto Coupler
Darlington Transistor
Marketization Model
CTR Rank:J/K/L
P:DIP6
S:SMD6
S:T3
L:T4

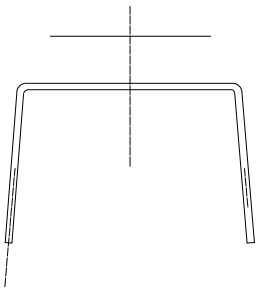

JOC
T372X
YWWZZX


LOT NO.

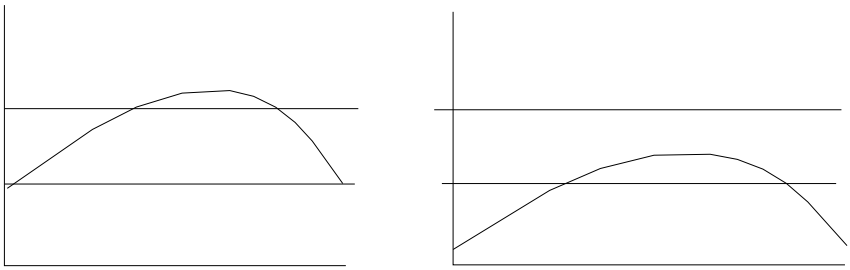
Max. Allowable LED Forward Current vs. Ambient Temperature

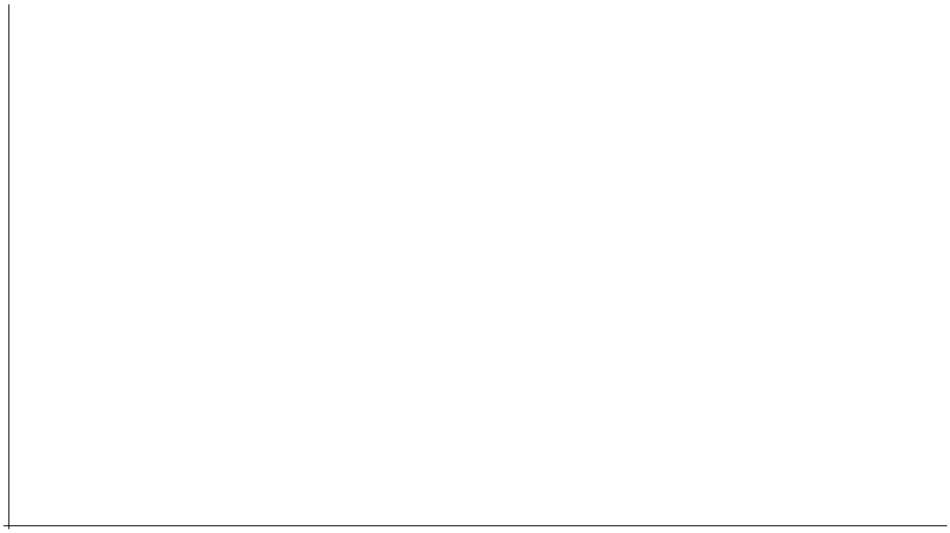


Collector Power Dissiption vs. Ambient Temperature



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
D0		1.50	1.60		0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	7.50
P1	11.90	12.00	.9	0.469	0.472	0..95
P2	1.90	2.00		0.075	0.079	
E	1.65	1.75		0.065	0.069	
F	7.40	7.50		0.291	0.295	
T	0.35	0.40		0.014	0.016	
W	15.70	16.00	16.30	0.618	0.630	0.642





TEL +86-513-68528666

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.

2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.

3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.

4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.

5. The component has a shelf life of one year when stored under standard conditions.

6. Recommend storage Temp.: 0~40°C;

Recommend storage Ď w midity: <60%;

MSL level: MSL 1